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REVISIONS

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Data Sheet

MTI04CS/MTI04CQ

MULTI-CHANNEL PROGRAMMABLE GAIN TRANSIMPEDANCE AMPLIFIER

Table of contents

| | |
|--|---|
| 1. GENERAL DESCRIPTION..... | 2 |
| 2. BLOCK DIAGRAM..... | 2 |
| 3. DESCRIPTION OF INTERFACE | 3 |
| 3.1 Pinning..... | 3 |
| 3.2 Adjustment of Transimpedance | 3 |
| 3.3 Switchable Frequency Range..... | 3 |
| 3.4 Power Down Modus..... | 3 |
| 4. DESCRIPTION OF FUNCTION | 4 |
| 5. ELECTRICAL CHARACTERISTICS | 4 |
| 5.1 Maximum Conditions | 4 |
| 5.2 Operating Conditions | 4 |
| 6. PACKAGES | 6 |
| 6.1 Shape And Dimensions | 6 |
| 6.2 Pin-Configuration | 7 |
| 7. ORDERING INFORMATION..... | 7 |
| 8. CONTACT..... | 7 |
| 9. APPLICATIONS | 8 |



electro optics

promis

MAZeT GmbH

Compiled: 2005-06-08

Status: valid

Checked: 2006-01-26

Released: 2006-01-26

DOC. NO: DB-05-175e

Page 1 of 8

| REVISIONS | | |
|-----------|---------|------------|
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| 1 | V 1.3 | 2006-01-26 |

1. GENERAL DESCRIPTION

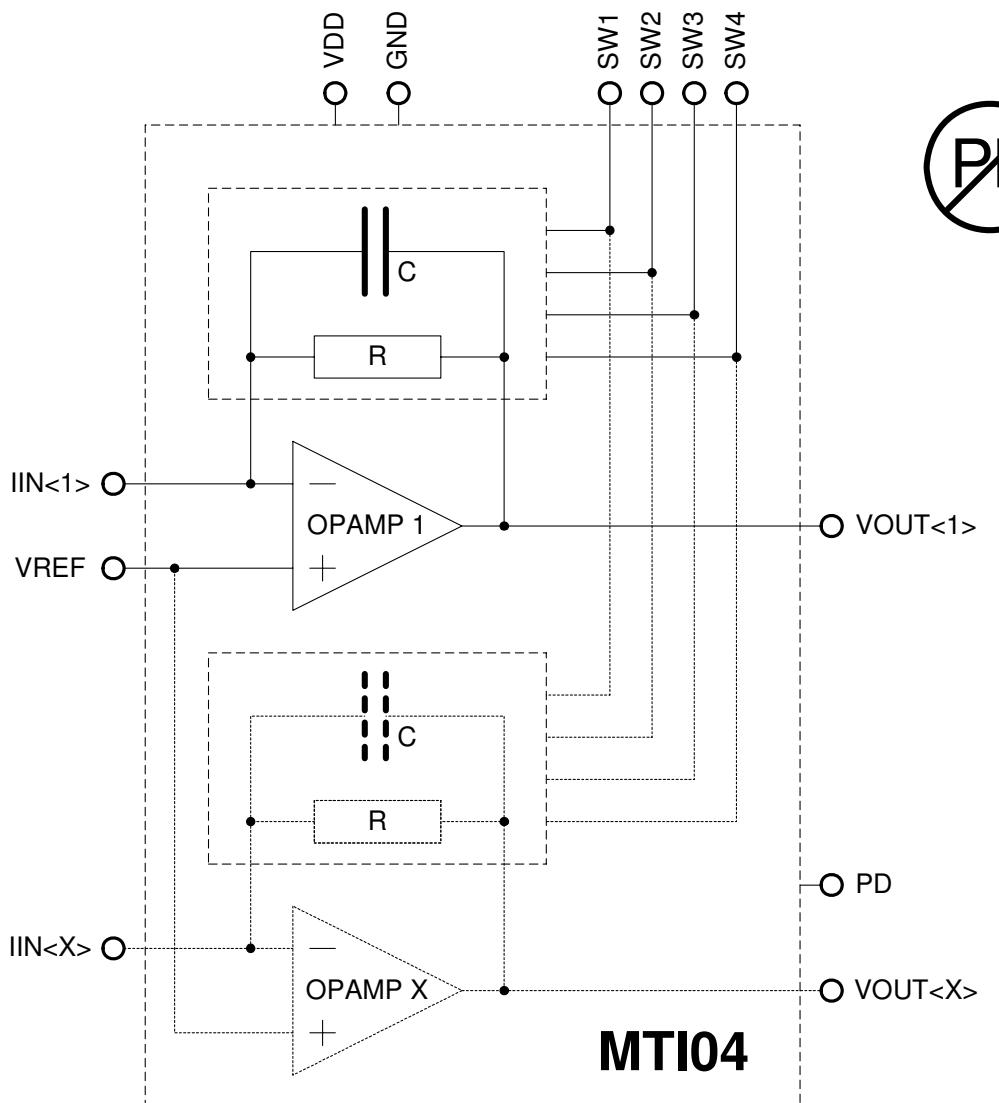
The MTI-devices are a family of integrated circuits of **programmable gain transimpedance amplifiers** with **4 channels** per IC (more custom specific, on request).

The MTI-devices are mainly used for **signal conditioning of sensors with current outputs**. They are especially suitable for connection of photodiodes of **array and row sensors**.

The possibility to **adjust the transimpedance in 8 stages** is a special feature.
The adjustment is made by programming three pins and is valid for all channels together.

The device packages (naked chip on request) are ROHS conform and optimized for **COB-mounting and SMD**.

2. BLOCK DIAGRAM



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DOC. NO:
DB-05-175e

Page 2 of 8

| REVISIONS | | |
|-----------|---------|------------|
| NO | VERSION | APPROVED |
| 1 | V 1.3 | 2006-01-26 |

3. DESCRIPTION OF INTERFACE

3.1 Pinning

| signal name | typ. | a/d ^a | function |
|-------------|--------|------------------|---|
| VDD | input | a/d | power supply |
| GND | input | a/d | power supply |
| VREF | input | a | reference voltage |
| SW1 | input | d | input 1 for adjustment of transimpedance of MTI-amplifier (pull down) |
| SW2 | input | d | input 2 for adjustment of transimpedance of MTI-amplifier (pull down) |
| SW3 | input | d | input 3 for adjustment of transimpedance of MTI-amplifier (pull down) |
| SW4 | input | d | switchable frequency range dependend on input capacitance of the photo-sensor (pull down) |
| PD | input | d | power down modus (pull down) |
| IIN<X> | input | a | analog current input of amplifier X |
| VOUT<X> | output | a | analog voltage output of amplifier X |

a.) analog or digital

3.2 Adjustment of Transimpedance

| settings of digital inputs | | | transimpedance R |
|----------------------------|-----|-----|-----------------------------|
| SW1 | SW2 | SW3 | |
| VDD | VDD | VDD | 20MΩ – stage 1 |
| GND | VDD | VDD | 10MΩ – stage 2 |
| GND | VDD | GND | 5MΩ – stage 3 |
| VDD | GND | VDD | 2MΩ – stage 4 |
| GND | GND | VDD | 1MΩ – stage 5 |
| VDD | GND | GND | 500kΩ – stage 6 |
| VDD | VDD | GND | 100kΩ – stage 7 |
| GND | GND | GND | 25kΩ ^b – stage 8 |

b.) default by pull down

3.3 Switchable Frequency Range

| settings of digital input | allowed capacitance of photo-sensor |
|---------------------------|-------------------------------------|
| SW4 | |
| VDD | < 5pF |
| GND | < 80pF ^c |

c.) default by pull down

3.4 Power Down Modus

| settings of digital input | bias current of the IC |
|---------------------------|------------------------|
| PD | |
| VDD | < 8μA |
| GND | typical |

d.) default by pull down



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DOC. NO:
DB-05-175e

Page 3 of 8

| REVISIONS | | |
|-----------|---------|------------|
| NO | VERSION | APPROVED |
| 1 | V 1.3 | 2006-01-26 |

4. DESCRIPTION OF FUNCTION

The MTI-devices are programmable gain transimpedance amplifiers with different numbers of channels (MTI04 – 4 channels). There is one transimpedance amplifier per channel between a current input $IIN<X>$ and a voltage output $VOUT<X>$. Its transimpedance is selectable in 8 stages. This adjustment can be effected by setting of digital inputs SW1, SW3 and SW4 and is valid for all channels simultaneously (headline 3.2).

Also simultaneously valid for all channels is a compensation of the input capacitance of photo-sensors for two possible frequency ranges (switchable by SW4, headline 3.3). The pins SW1, SW2, SW3 and SW4 are pull down inputs.

The second input of all transimpedance amplifiers is used for a *common* supply by a reference voltage necessarily fed in through the pin VREF.

All channels are compensated for an external input capacitance of the photo-sensor of smaller than 80pF (SW4 = GND).

The power supply for the MTI-devices is typical 3V to 5V between VDD and GND. The power down modus is adjusted by PD = VDD and switches off the functionality.

5. ELECTRICAL CHARACTERISTICS

5.1 Maximum Conditions

Violations of absolute maximum conditions are not allowed under any circumstances, otherwise the IC can be destroyed.

All voltages are referenced to GND = 0V.

| parameter | name | min. | max. | unit |
|---------------------------|--------------|------|---------|------|
| power supply | VDD | 0.3 | 7.0 | V |
| input and output voltages | ⇒ IC-pinning | 0.3 | VDD+0.3 | V |
| power dissipation | P_{OP} | | 0.025 | W |
| operating temperature | T_{OP} | -40 | 125 | °C |
| storage temperature | T_{STG} | 55 | 155 | °C |

5.2 Operating Conditions

All voltages are referenced to GND = 0V.

| parameter | name | min. | typ. | max. | unit | condition |
|-----------------------|----------|---------|--------|---------|------|-------------------|
| supply voltage | VDD | 2.7 | 3 to 5 | 5.5 | V | |
| bias current MTI04 | $I(VDD)$ | | 2.5 | 4.0 | mA | 27°C, VDD=5.5V |
| bias current MTI04 | $I(VDD)$ | | | 8 | μA | PD=VDD |
| operating temperature | T_{OP} | -40 | 27 | 125 | °C | |
| input high level | V_{IH} | 0.7*VDD | | VDD+0.3 | V | |
| input low level | V_{IL} | -0.3 | | 0.8 | V | |
| reference voltage | VREF | 0.4 | | VDD-0.4 | V | |



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DOC. NO:
DB-05-175e

Page 4 of 8

| NO | VERSION | APPROVED |
|----|---------|------------|
| 1 | V 1.3 | 2006-01-26 |

AC/DC-Characteristics

Unless otherwise specified the data in this table is valid for $T_{OP} = 27^\circ\text{C}$ and $VDD = 5\text{V}$. All voltages are referenced to GND = 0V.

| parameter | name | min. | typ. | max. | unit | condition |
|---|-------------------------------------|-------|-------|-------|------------------|---|
| input current | I _{IIN<X>} | | 0.025 | | μA | stage 1 |
| | | | 0.05 | | μA | stage 2 |
| | | | 0.1 | | μA | stage 3 |
| | | | 0.25 | | μA | stage 4 |
| | | | 0.5 | | μA | stage 5 |
| | | | 1 | | μA | stage 6 |
| | | | 5 | | μA | stage 7 |
| | | | 20 | | μA | stage 8 |
| feedback resistor | R | 14000 | 20000 | 26700 | $\text{k}\Omega$ | stage 1 |
| | | 7000 | 10000 | 13350 | $\text{k}\Omega$ | stage 2 |
| | | 3500 | 5000 | 6700 | $\text{k}\Omega$ | stage 3 |
| | | 1400 | 2000 | 2670 | $\text{k}\Omega$ | stage 4 |
| | | 700 | 1000 | 1335 | $\text{k}\Omega$ | stage 5 |
| | | 350 | 500 | 670 | $\text{k}\Omega$ | stage 6 |
| | | 70 | 100 | 133 | $\text{k}\Omega$ | stage 7 |
| | | 17 | 25 | 34 | $\text{k}\Omega$ | stage 8 |
| signal frequency at input SW4 = GND ($C_{\text{PHOTO-SENSOR}} < 80\text{pF}$) | $f_{3\text{dB}}$ | 4 | 6 | 16 | kHz | stage 1, $T_{OP} (5.2)$ |
| | | 7 | 11 | 28 | kHz | stage 2, $T_{OP} (5.2)$ |
| | | 11 | 16 | 42 | kHz | stage 3, $T_{OP} (5.2)$ |
| | | 18 | 26 | 66 | kHz | stage 4, $T_{OP} (5.2)$ |
| | | 25 | 35 | 95 | kHz | stage 5, $T_{OP} (5.2)$ |
| | | 35 | 50 | 130 | kHz | stage 6, $T_{OP} (5.2)$ |
| | | 80 | 120 | 280 | kHz | stage 7, $T_{OP} (5.2)$ |
| | | 160 | 300 | 580 | kHz | stage 8, $T_{OP} (5.2)$ |
| signal frequency at input SW4 = VDD ($C_{\text{PHOTO-SENSOR}} < 5\text{pF}$) | $f_{3\text{dB}}$ | 4 | 6 | 16 | kHz | stage 1, $T_{OP} (5.2)$ |
| | | 7 | 11 | 28 | kHz | stage 2, $T_{OP} (5.2)$ |
| | | 14 | 21 | 45 | kHz | stage 3, $T_{OP} (5.2)$ |
| | | 35 | 54 | 130 | kHz | stage 4, $T_{OP} (5.2)$ |
| | | 70 | 110 | 260 | kHz | stage 5, $T_{OP} (5.2)$ |
| | | 100 | 160 | 360 | kHz | stage 6, $T_{OP} (5.2)$ |
| | | 260 | 380 | 780 | kHz | stage 7, $T_{OP} (5.2)$ |
| | | 500 | 800 | 1700 | kHz | stage 8, $T_{OP} (5.2)$ |
| temperature coefficient of the feedback resistor | TC_R | | -3300 | | ppm/ K | |
| offset voltage | V_{OFF}^1 | -10 | | 10 | mV | $T_{OP} (5.2)$ |
| capacitive load at $VOUT<X>$ | C_{LOAD} | | | 50 | pF | $I_{LOAD} < 0.5\text{mA}$ per output |
| pull down current SW1, SW2, SW3, SW4, PD | I_{PDPAD} | | | 200 | μA | digital inputs |
| input capacitance of external connected photo-sensors | $C_{\text{PHOTO-}}_{\text{SENSOR}}$ | | | 80 | pF | per input $SW4 = \text{GND}$ |
| input capacitance of external connected photo-sensors | $C_{\text{PHOTO-}}_{\text{SENSOR}}$ | | | 5 | pF | per input $SW4 = \text{VDD}$ |
| tolerance of the feedback resistors between the four channels | TOL_R^2 | 1 | | 10 | % | DC input current; for all stages |



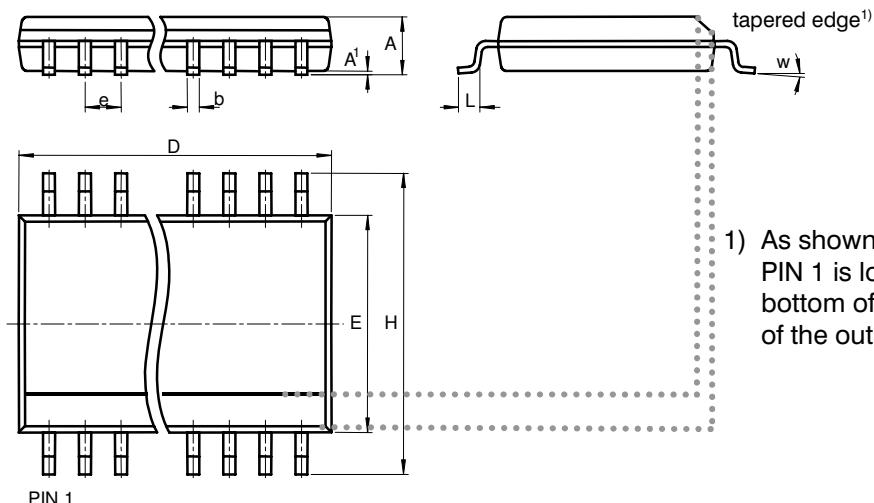
¹ $V_{OFF} = VOUT<X> - VREF$; results from input offset voltage and input leakage current

² up to max. 1% available on request

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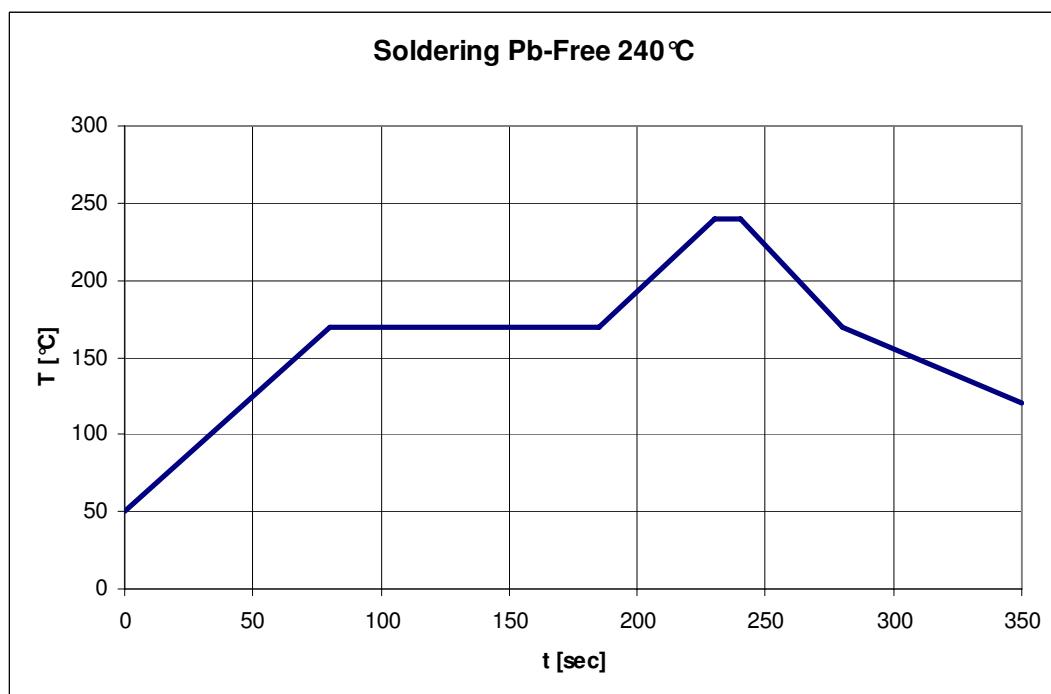
6. PACKAGES

6.1 Shape And Dimensions



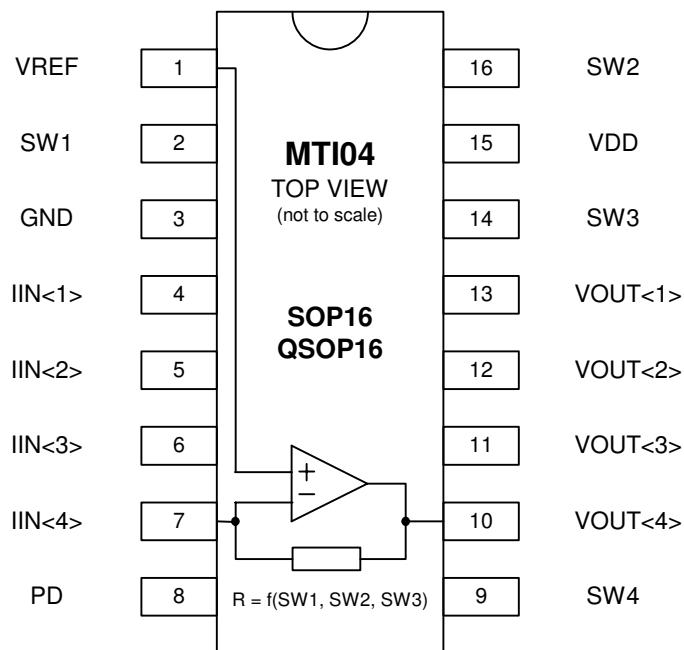
- 1) As shown in the figure
PIN 1 is located on the
bottom of the left corner
of the outline.

| TYP | PACKAGE | D | E | H | A | A1 | e | b | L | w |
|---------|---------|------|------|------|------|------|-------|------|------|----|
| MTI04CS | SOP16 | 9.90 | 3.80 | 6.00 | 1.75 | 0.15 | 1.27 | 0.41 | 0.72 | 4° |
| MTI04CQ | QSOP16 | 4.90 | 3.80 | 6.00 | 1.75 | 0.15 | 0.635 | 0.38 | 0.72 | 4° |



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6.2 Pin-Configuration



7. ORDERING INFORMATION

| NAME OF PRODUCT | PACKAGE | NUMBER OF CHANNELS |
|-----------------|---------|--------------------|
| MTI04CS | SOP16 | 4 |
| MTI04CQ | QSOP16 | 4 |

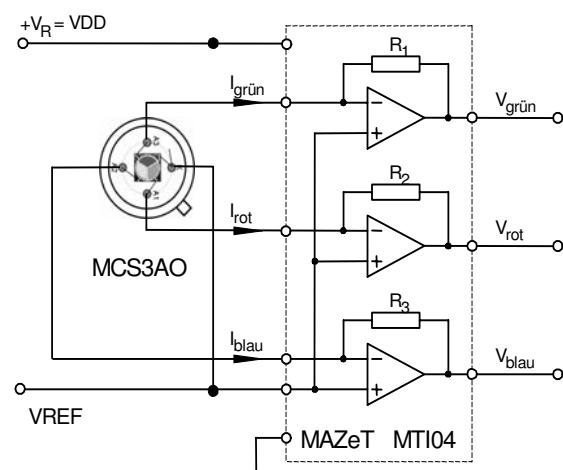
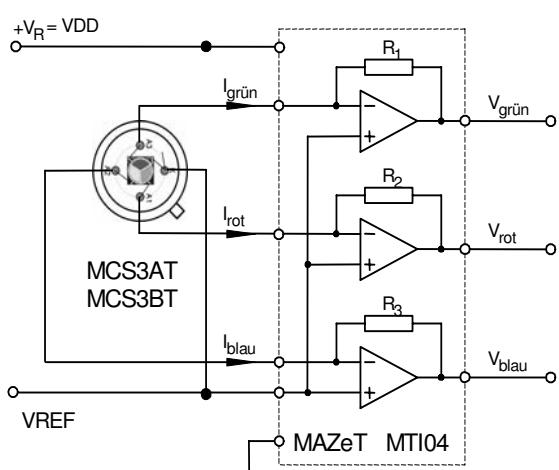
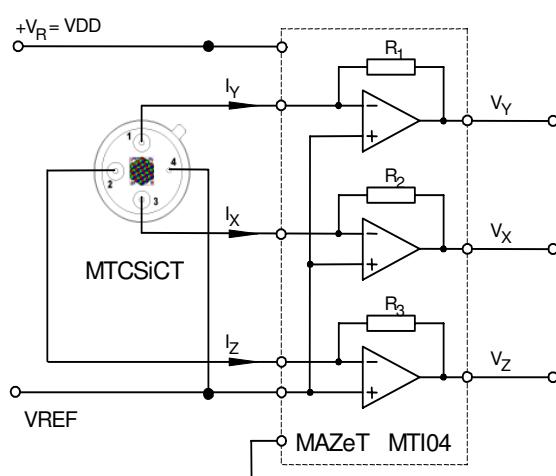
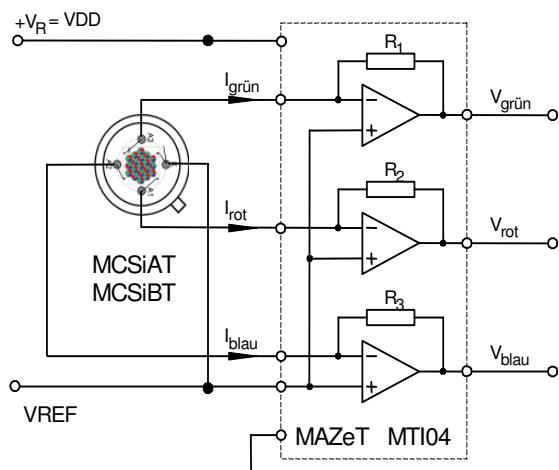
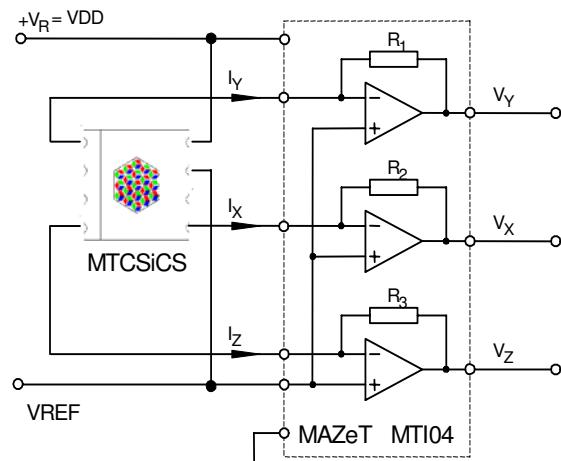
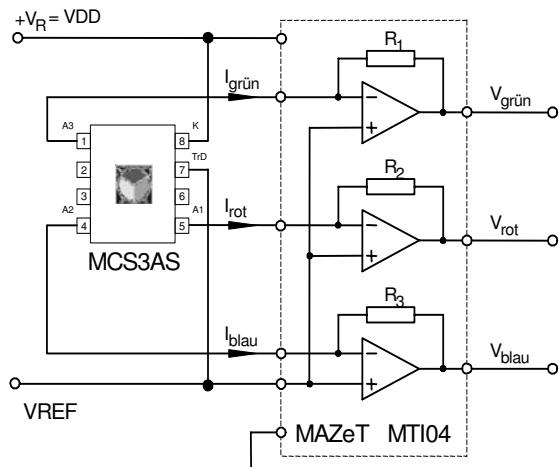
8. CONTACT

For further information, please feel free to contact:

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9. APPLICATIONS

Connection of MAZeT Colour Sensor



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Page 8 of 8